L Number	Hits	Search Text	DB	Time stamp
1	304		USPAT;	2003/03/10 12:41
		silicon) with (particles or particle or	US-PGPUB;	, , , , , , , , , , , , , , , , , , , ,
		fillers or filler)	EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	1	("20010039300").PN.	USPAT;	2003/03/10 12:51
			US-PGPUB	
2	15	, tree Francockarracticy relie, and	USPAT;	2003/03/10 13:17
		silicon) near (particles or particle or	US-PGPUB;	
		fillers or filler)	EPO; JPO;	
į i			DERWENT;	
			IBM TDB	
8	102		USPAT;	2003/03/10 13:14
		or PWB or (printed near board))	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
9	166	((ptfe or poltetrafluoroetheylene) with (si	USPAT;	2003/03/10 13:18
		or silicon))and (chip or die)	US-PGPUB;	
			EPO; JPO;	.
	ĺ		DERWENT;	
1.0		*	IBM_TDB	
10	166	((ptfe or polytetrafluoroetheylene) with (si	USPAT;	2003/03/10 13:19
]		or silicon))and (chip or die)	US-PGPUB;	
			EPO; JPO;	ĺ
			DERWENT;	
111		1// 1/5	IBM_TDB	
11	3	(((ptfe or polytetrafluoroetheylene) with	USPAT;	2003/03/10 13:22
		(si or silicon)) and (chip or die)) and (pcb	US-PGPUB;	
		or pwb or (print\$2 adj board))	EPO; JPO;	
			DERWENT;	
12			IBM_TDB	
12	119	(((ptfe or polytetrafluoroetheylene) with	USPAT;	2003/03/10 13:30
		(si or silicon)) and (chip or die)) and	US-PGPUB;	
		substrate	EPO; JPO;	
			DERWENT;	
13	1	(11.62.0.02.0.0.11) 737	IBM_TDB	
13	<u>+1</u>	("6388208").PN.	USPAT	2003/03/10 13:30